Onsemi

MOSFET – Power, Single **N-Channel**

60 V, 48 A, 10 mΩ

NVMFS5H610NL

Features

- Small Footprint (5x6 mm) for Compact Design
- Low RDS(on) to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFS5H610NLWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Symbol	Para	neter		Value	Unit
V _{DSS}	Drain-to-Source Voltag		60	V	
V _{GS}	Gate-to-Source Voltag	е		±20	V
I _D	Continuous Drain		T _C = 25°C	48	А
	Current R _{θJC} (Notes 1, 3)	Steady	T _C = 100°C	34	
PD	Power Dissipation	State	T _C = 25°C	52	W
	R _{θJC} (Note 1)		$T_{C} = 100^{\circ}C$	26	
I _D	Continuous Drain		T _A = 25°C	13	А
	Current R _{θJA} (Notes 1, 2, 3)	Steady	T _A = 100°C	9	
P _D	Power Dissipation	State	T _A = 25°C	3.6	W
	R _{θJA} (Notes 1, 2)		T _A = 100°C	1.8	
I _{DM}	Pulsed Drain Current	T _A = 25	°C, t _p = 10 μs	243	А
T _J , T _{stg}	Operating Junction and Storage Temperature Range			– 55 to +175	°C
۱ _S	Source Current (Body Diode)			43	А
E _{AS}	Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 2.8 A)			175	mJ
TL	Lead Temperature for S (1/8" from case for 10 s		Purposes	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Junction-to-Case - Steady State	2.9	°C/W
$R_{\theta JA}$	Junction-to-Ambient - Steady State (Note 2)	42	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad. 2

3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
60 V	10 mΩ @ 10 V	48 A
60 V	13 m Ω @ 4.5 V	48 A

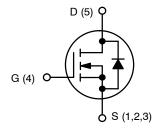




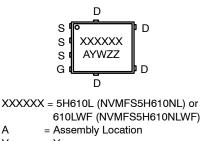
DFN5 (SO-8FL) CASE 488AA STYLE 1

DFNW5 (FULL-CUT SO8FL WF) CASE 507BA





MARKING DIAGRAM



= Year

A

Y

W

- = Work Week
- 77 = Lot Traceability

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

NOTE: Some of the devices on this data sheet have been DISCONTINUED. Please refer to the table on page 5.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Test Condition		Min	Тур	Max	Unit
OFF CHAR	ACTERISTICS						
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	$V_{GS} = 0 V, I_D =$	V_{GS} = 0 V, I_D = 250 μ A				V
V _{(BR)DSS} / T _J	Drain-to-Source Breakdown Voltage Temperature Coefficient				39.2		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{GS} = 0 V, V _{DS} = 60 V	T _J = 25 °C			10	
		v _{DS} = 60 v	T _J = 125°C			250	μΑ
I _{GSS}	Gate-to-Source Leakage Current	$V_{DS} = 0 V, V_{GS}$	V _{DS} = 0 V, V _{GS} = 20 V			100	nA

ON CHARACTERISTICS (Note 4)

V _{GS(TH)}	Gate Threshold Voltage	V_{GS} = V_{DS} , I_D = 40 μ A		1.2		2.0	V
V _{GS(TH)} /T _J	Threshold Temperature Coefficient				-5.0		mV/°C
R _{DS(on)}	Drain-to-Source On Resistance	V _{GS} = 10 V	I _D = 8 A		8.0	10	mΩ
		V _{GS} = 4.5 V	I _D = 7 A		10.5	13	11152

CHARGES, CAPACITANCES & GATE RESISTANCE

C _{ISS}	Input Capacitance		880	
C _{OSS}	Output Capacitance	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 30 V	150	pF
C _{RSS}	Reverse Transfer Capacitance		6.0	
Q _{OSS}	Output Charge	V_{GS} = 0 V, V_{DD} = 30 V	12	
Q _{G(TOT)}	Total Gate Charge	V_{GS} = 10 V, V_{DS} = 30 V; I_D = 8 A	13.7	
Q _{G(TOT)}	Total Gate Charge		6.4	nC
Q _{G(TH)}	Threshold Gate Charge		1.6	nc
Q _{GS}	Gate-to-Source Charge	V _{GS} =4.5 V, V _{DS} = 30 V; I _D = 8 A	2.6	
Q _{GD}	Gate-to-Drain Charge		1.3	
V _{GP}	Plateau Voltage		2.6	V

SWITCHING CHARACTERISTICS (Note 5)

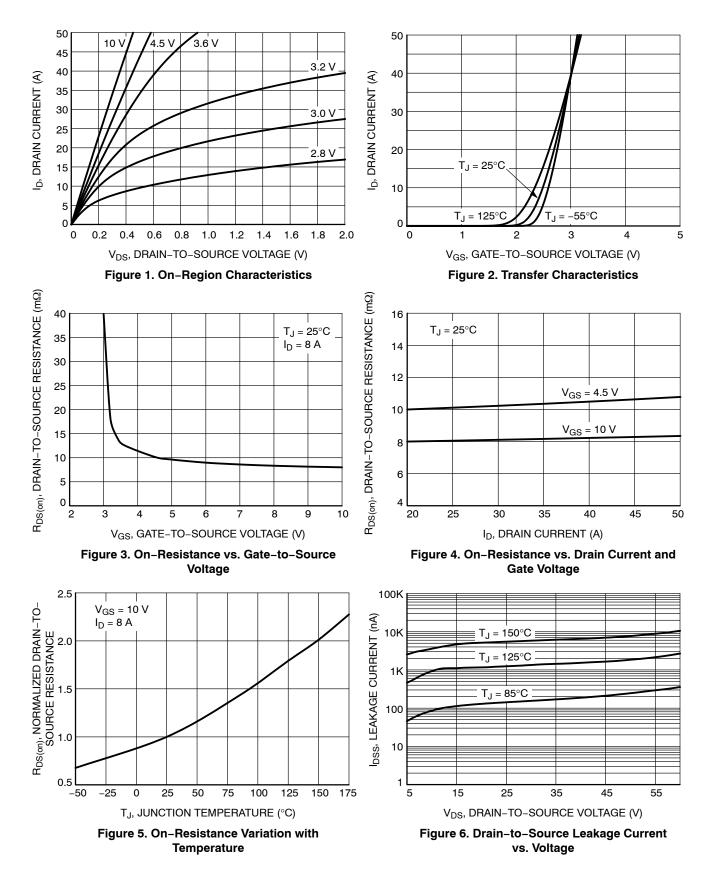
t _{d(ON)}	Turn-On Delay Time		9.5	
t _r	Rise Time	V _{GS} = 4.5 V, V _{DS} = 48 V,	23	20
t _{d(OFF)}	Turn-Off Delay Time	I_D = 8 A, R_G = 2.5 Ω	22	ns
t _f	Fall Time		6	

DRAIN-SOURCE DIODE CHARACTERISTICS

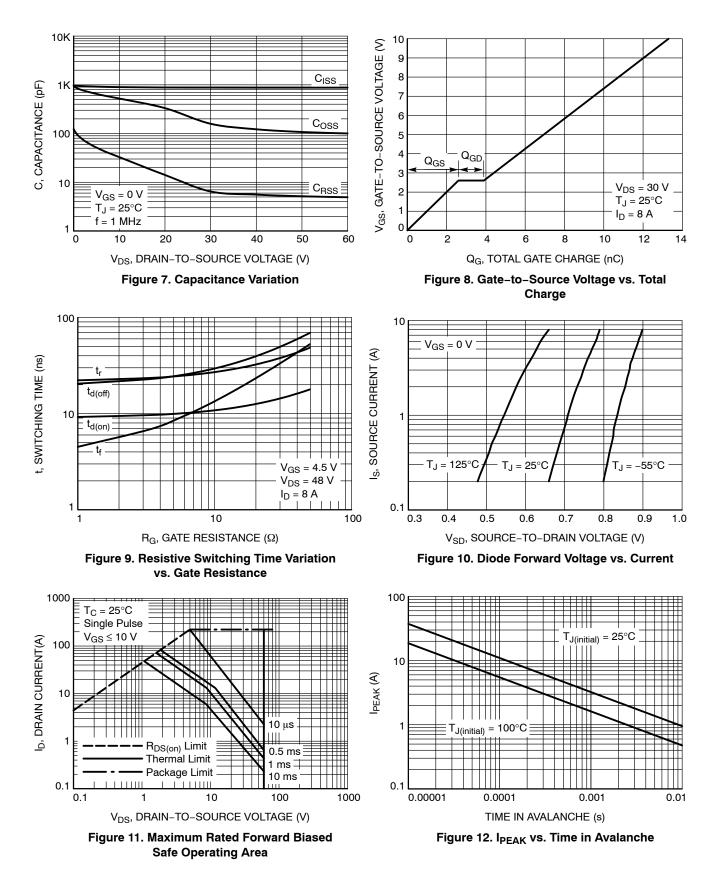
V _{SD}	Forward Diode Voltage	V _{GS} = 0 V, I _S = 8 A	$T_J = 25^{\circ}C$	0.8	1.2	V
		I _S = 8 A	T _J = 125°C	0.65		v
t _{RR}	Reverse Recovery Time			24		
ta	Charge Time	V _{GS} = 0 V, dI _S /dt = 100 A/µs, I _S = 4 A		15		ns
t _b	Discharge Time			9		
Q _{RR}	Reverse Recovery Charge			17		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width $\leq 300 \ \mu$ s, duty cycle $\leq 2\%$. 5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (continued)



TYPICAL CHARACTERISTICS (continued)

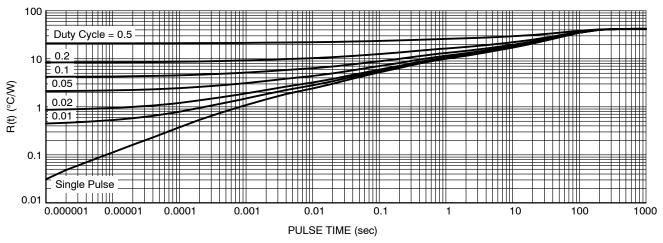


Figure 13. Thermal Characteristics

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NVMFS5H610NLWFT1G	610LWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel

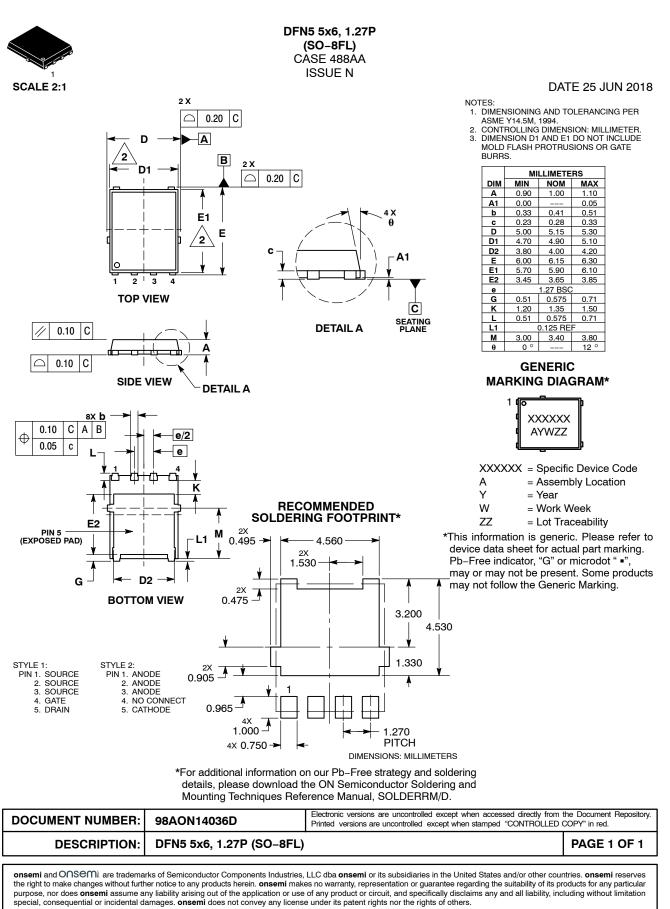
DISCONTINUED (Note 6)

NVMFS5H610NLT1G	5H610L	DFN5 (Pb–Free)	1500 / Tape & Reel
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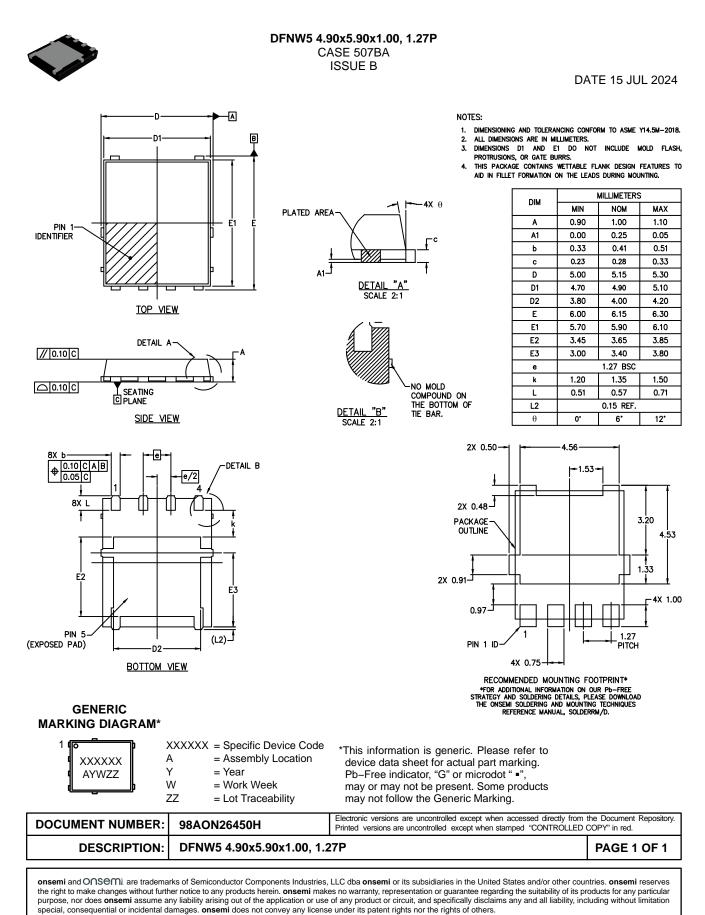
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

6. **DISCONTINUED:** This device is not recommended for new design. Please contact your **onsemi** representative for information. The most current information on this device may be available on <u>www.onsemi.com</u>.

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